

## PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">MSPM0C1103S8YCJR</a>	Active	Production	DSBGA (YCJ)   8	12000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	03
<a href="#">MSPM0C1103SDDFR</a>	Active	Production	SOT-23-THIN (DDF)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C03S
MSPM0C1103SDDFR.A	Active	Production	SOT-23-THIN (DDF)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C03S
MSPM0C1103SDDFR.B	Active	Production	SOT-23-THIN (DDF)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C03S
<a href="#">MSPM0C1103SDGS20R</a>	Active	Production	VSSOP (DGS)   20	5000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	M0C1103S
MSPM0C1103SDGS20R.A	Active	Production	VSSOP (DGS)   20	5000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	M0C1103S
MSPM0C1103SDGS20R.B	Active	Production	VSSOP (DGS)   20	5000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	M0C1103S
<a href="#">MSPM0C1103SDSGR</a>	Active	Production	WSO (DSG)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C03S
MSPM0C1103SDSGR.A	Active	Production	WSO (DSG)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C03S
MSPM0C1103SDSGR.B	Active	Production	WSO (DSG)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C03S
<a href="#">MSPM0C1103SDYYR</a>	Active	Production	SOT-23-THIN (DYY)   16	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	M0C1103S
MSPM0C1103SDYYR.A	Active	Production	SOT-23-THIN (DYY)   16	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	M0C1103S
MSPM0C1103SDYYR.B	Active	Production	SOT-23-THIN (DYY)   16	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	M0C1103S
<a href="#">MSPM0C1103SRUKR</a>	Active	Production	WQFN (RUK)   20	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C1103S
MSPM0C1103SRUKR.A	Active	Production	WQFN (RUK)   20	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C1103S
MSPM0C1103SRUKR.B	Active	Production	WQFN (RUK)   20	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C1103S
<a href="#">MSPM0C1104S8YCJR</a>	Active	Production	DSBGA (YCJ)   8	12000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	04
<a href="#">MSPM0C1104SDDFR</a>	Active	Production	SOT-23-THIN (DDF)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C04S
MSPM0C1104SDDFR.A	Active	Production	SOT-23-THIN (DDF)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C04S
MSPM0C1104SDDFR.B	Active	Production	SOT-23-THIN (DDF)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C04S
<a href="#">MSPM0C1104SDGS20R</a>	Active	Production	VSSOP (DGS)   20	5000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	M0C1104S
MSPM0C1104SDGS20R.A	Active	Production	VSSOP (DGS)   20	5000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	M0C1104S
MSPM0C1104SDGS20R.B	Active	Production	VSSOP (DGS)   20	5000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	M0C1104S
<a href="#">MSPM0C1104SDSGR</a>	Active	Production	WSO (DSG)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C04S
MSPM0C1104SDSGR.A	Active	Production	WSO (DSG)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C04S
MSPM0C1104SDSGR.B	Active	Production	WSO (DSG)   8	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C04S

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">MSPM0C1104SDYYR</a>	Active	Production	SOT-23-THIN (DYY)   16	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	M0C1104S
MSPM0C1104SDYYR.A	Active	Production	SOT-23-THIN (DYY)   16	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	M0C1104S
MSPM0C1104SDYYR.B	Active	Production	SOT-23-THIN (DYY)   16	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	M0C1104S
<a href="#">MSPM0C1104SRUKR</a>	Active	Production	WQFN (RUK)   20	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C1104S
MSPM0C1104SRUKR.A	Active	Production	WQFN (RUK)   20	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C1104S
MSPM0C1104SRUKR.B	Active	Production	WQFN (RUK)   20	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	C1104S
<a href="#">MSPS003F3SPW20R</a>	Active	Production	TSSOP (PW)   20	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	MS003F3
MSPS003F3SPW20R.A	Active	Production	TSSOP (PW)   20	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	MS003F3
MSPS003F3SPW20R.B	Active	Production	TSSOP (PW)   20	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	MS003F3
<a href="#">MSPS003F4SPW20R</a>	Active	Production	TSSOP (PW)   20	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	MS003F4
MSPS003F4SPW20R.A	Active	Production	TSSOP (PW)   20	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	MS003F4
MSPS003F4SPW20R.B	Active	Production	TSSOP (PW)   20	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	MS003F4
<a href="#">XMSM0C1104S8YCJR</a>	Active	Preproduction	DSBGA (YCJ)   8	12000   LARGE T&R	-	Call TI	Call TI	-40 to 125	
XMSM0C1104S8YCJR.B	Active	Preproduction	DSBGA (YCJ)   8	12000   LARGE T&R	-	Call TI	Call TI	-40 to 125	
XMSM0C1104SDDFR.B	Active	Preproduction	SOT-23-THIN (DDF)   8	3000   LARGE T&R	-	Call TI	Call TI	-40 to 125	
XMSM0C1104SDSGR.B	Active	Preproduction	WSON (DSG)   8	3000   LARGE T&R	-	Call TI	Call TI	-40 to 125	
XMSM0C1104SDYYR.B	Active	Preproduction	SOT-23-THIN (DYY)   16	3000   LARGE T&R	-	Call TI	Call TI	-40 to 125	
XMSM0C1104SRUKR.B	Active	Preproduction	WQFN (RUK)   20	3000   LARGE T&R	-	Call TI	Call TI	-40 to 125	

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**(5) MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

**(6) Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

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**OTHER QUALIFIED VERSIONS OF MSPM0C1103, MSPM0C1104 :**

- Automotive : [MSPM0C1103-Q1](#), [MSPM0C1104-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects